

**Vishay Siliconix** 

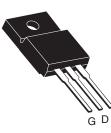
**RoHS** 

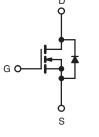
## **Power MOSFET**

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	600				
R <sub>DS(on)</sub> (Ω)	V <sub>GS</sub> = 10 V	2.2			
Q <sub>g</sub> (Max.) (nC)	31				
Q <sub>gs</sub> (nC)	4.6				
Q <sub>gd</sub> (nC)	17				
Configuration	Single				

S

#### TO-220 FULLPAK





N-Channel MOSFET

### FEATURES

- Isolated Package
- High Voltage Isolation = 2.5 kV<sub>RMS</sub> (t = 60 s; f = 60 Hz)
- Sink to Lead Creepage Distance = 4.8 mm
- Dynamic dV/dt Rating
- · Low Thermal Resistance
- Lead (Pb)-free Available

### DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220 FULLPAK eliminates the need for additional insulating hardware in commercial-industrial applications. The moulding compound used provides a high isolation capability and a low thermal resistance between the tab and external heatsink. This isolation is equivalent to using a 100 micron mica barrier with standard TO-220 product. The FULLPAK is mounted to a heatsink using a single clip or by a single screw fixing.

ORDERING INFORMATION	
Package	TO-220 FULLPAK
Lead (Pb)-free	IRFIBC30GPbF
	SiHFIBC30G-E3
SnPb	IRFIBC30G
	SiHFIBC30G

ABSOLUTE MAXIMUM RATINGS T	<sub>C</sub> = 25 °C, u	nless otherw	ise noted			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V <sub>DS</sub>	600	V	
Gate-Source Voltage			V <sub>GS</sub>	± 20	V V	
Continuous Drain Current	V <sub>GS</sub> at 10 V	$T_C = 25 \degree C$ $T_C = 100 \degree C$	- I <sub>D</sub>	2.5		
	VGS AL TO V	T <sub>C</sub> = 100 °C		1.6	А	
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	10		
Linear Derating Factor			0.28	W/°C		
Single Pulse Avalanche Energy <sup>b</sup>		E <sub>AS</sub>	250	mJ		
Repetitive Avalanche Current <sup>a</sup>			I <sub>AR</sub>	2.5	А	
Repetitive Avalanche Energy <sup>a</sup>			E <sub>AR</sub>	3.5	mJ	
Maximum Power Dissipation	T <sub>C</sub> =	25 °C	PD	35	W	
Peak Diode Recovery dV/dt <sup>c</sup>			dV/dt	3.0	V/ns	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 150	°C		
Soldering Recommendations (Peak Temperature)	for	10 s		300 <sup>d</sup>		
Mounting Torque	6 20 or l	6.00 or M0 corow		10	lbf ⋅ in	
	6-32 or M3 screw			1.1	N · m	

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b.  $V_{DD} = 50$  V, starting  $T_J = 25$  °C, L = 73 mH,  $R_G = 25 \Omega$ ,  $I_{AS} = 2.5$  A (see fig. 12).

c.  $I_{SD} \leq 3.6$  A,  $dI/dt \leq 60$  A/µs,  $V_{DD} \leq V_{DS}, \, T_J \leq 150 \ ^{\circ}C.$ 

d. 1.6 mm from case.

\* Pb containing terminations are not RoHS compliant, exemptions may apply

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THERMAL RESISTANCE RAT	rings								
PARAMETER	SYMBOL	ТҮР	•	MAX.		UNIT			
Maximum Junction-to-Ambient	R <sub>thJA</sub>	- 65			°C 111				
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	- 3.6				°C/W			
<b>SPECIFICATIONS</b> $T_J = 25 \ ^{\circ}C$ , 1	unless otherv	vise noted							
PARAMETER	SYMBOL	1	T CONDITI	ONS	MIN.	TYP.	MAX.	UNI	
Static									
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = 2	50 µA	600	-	-	V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_J$	Reference	e to 25 °C,	I <sub>D</sub> = 1 mA	-	0.62	-	V/°C	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 2	250 μA	2.0	-	4.0	V	
Gate-Source Leakage	I <sub>GSS</sub>	,	$V_{\rm GS} = \pm 20$	V	-	-	± 100	nA	
Zerra Osta Malta en Ducia Osmanl		V <sub>DS</sub> = 600 V, V <sub>GS</sub> = 0 V			-	-	100	μA	
Zero Gate Voltage Drain Current	Voltage Drain Current $I_{DSS}$ $V_{DS} = 480 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 \text{ °C}$		, T <sub>J</sub> = 125 °C	-	-	500			
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub>	= 1.5 A <sup>b</sup>	-	-	2.2	Ω	
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> =	= 50 V, I <sub>D</sub> =	1.5 A <sup>b</sup>	2.2	-	-	S	
Dynamic									
Input Capacitance	Ciss	$V_{GS} = 0 V, V_{DS} = 25 V, f = 1.0 MHz, see fig. 5 f = 1.0 MHz$		-	660	-	pF		
Output Capacitance	C <sub>oss</sub>			-	86	-			
Reverse Transfer Capacitance	C <sub>rss</sub>			-	19	-			
Drain to Sink Capacitance	С			-	12	-			
Total Gate Charge	Qg				-	-	31	nC	
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V		6 A, V <sub>DS</sub> = 360 V, fig. 6 and 13 <sup>b</sup>	-	-	4.6		
Gate-Drain Charge	$Q_gd$		See ng		-	-	17	1	
Turn-On Delay Time	t <sub>d(on)</sub>				-	11	-	1	
Rise Time	t <sub>r</sub>		$V_{DD} = 300 \text{ V}, \text{ I}_{D} = 3.6 \text{ A},$		-	13	-	1	
Turn-Off Delay Time	t <sub>d(off)</sub>	$R_G = 12 \Omega$ , $R_D = 82 \Omega$ , see fig. $10^b$		-	35	-	ns		
Fall Time	t <sub>f</sub>			-	14	-			
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-			
Internal Source Inductance	L <sub>S</sub>			-	7.5	-	nH		
Drain-Source Body Diode Characteristic	s				1	1	1	1	
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the		-	-	2.5	- A		
Pulsed Diode Forward Currenta	I <sub>SM</sub>	integral reverse p - n junction diode			-	-		10	
Body Diode Voltage	V <sub>SD</sub>	$T_{J} = 25 \ ^{\circ}C, \ I_{S} = 2.5 \ A, \ V_{GS} = 0 \ V^{b}$		-	-	1.6	V		
Body Diode Reverse Recovery Time	t <sub>rr</sub>	$T_J = 25 \text{ °C}, I_F = 3.6 \text{ A}, dI/dt = 100 \text{ A}/\mu\text{s}^b$		-	400	810	ns		
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			-	2.1	4.2	μC		
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-on is dominated by $L_S$ and $L_D$ )							

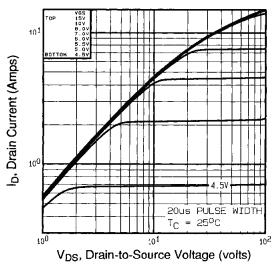
#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width  $\leq$  300  $\mu s;$  duty cycle  $\leq$  2 %.

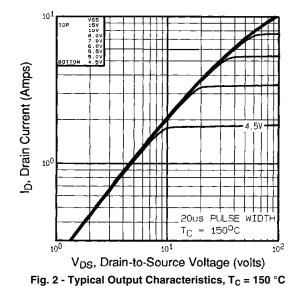


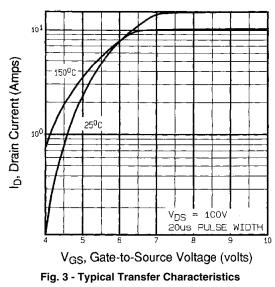
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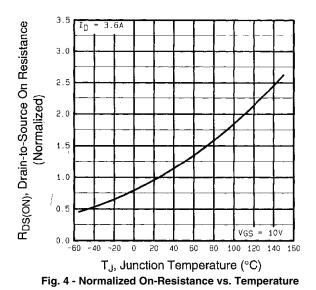


### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

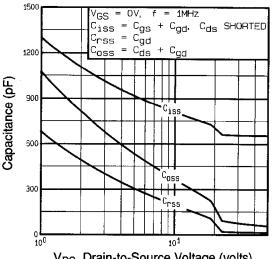








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V<sub>DS</sub>, Drain-to-Source Voltage (volts) Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

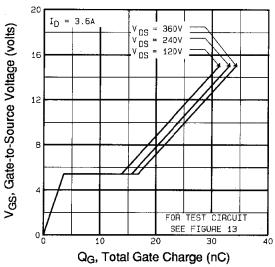
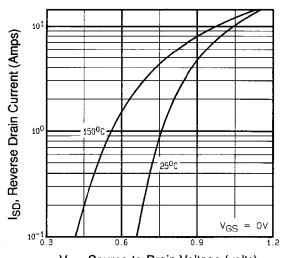
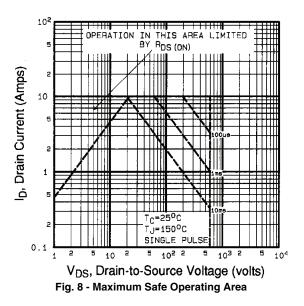


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



V<sub>SD</sub>, Source-to-Drain Voltage (volts) Fig. 7 - Typical Source-Drain Diode Forward Voltage





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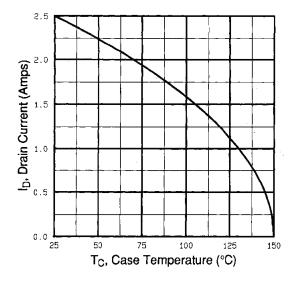


Fig. 9 - Maximum Drain Current vs. Case Temperature

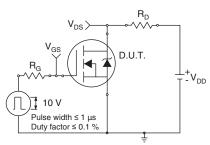


Fig. 10a - Switching Time Test Circuit

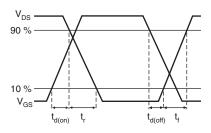
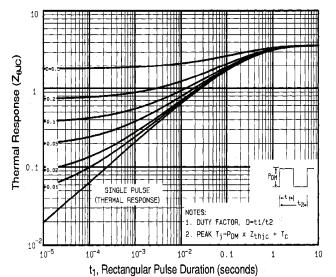


Fig. 10b - Switching Time Waveforms





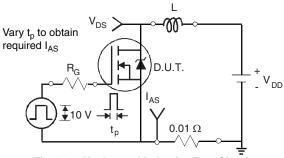


Fig. 12a - Unclamped Inductive Test Circuit

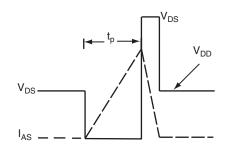


Fig. 12b - Unclamped Inductive Waveforms

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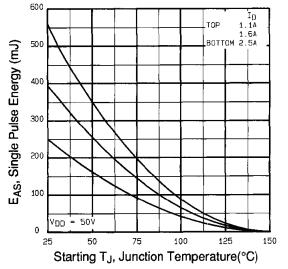


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

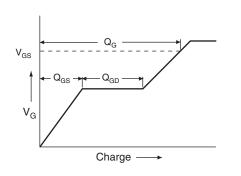


Fig. 13a - Basic Gate Charge Waveform

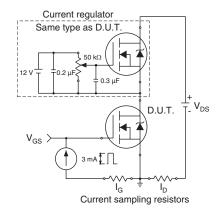
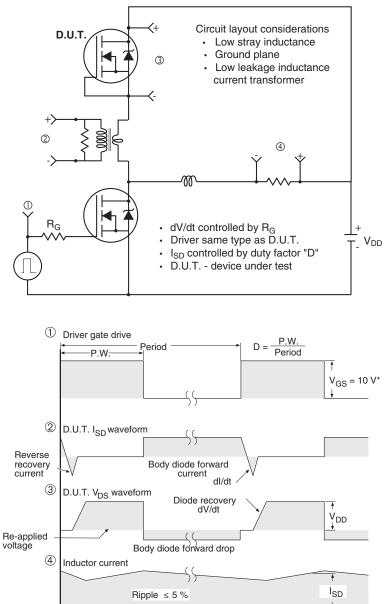


Fig. 13b - Gate Charge Test Circuit



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Peak Diode Recovery dV/dt Test Circuit

\*  $V_{GS}$  = 5 V for logic level devices and 3 V drive devices

Fig. 14 - For N-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <u>www.vishay.com/ppg?91180</u>.



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